

SEMPACK® 0 Twin Thyristor Modules for a.c. controllers

SKKQ 31
SKKQ 45



Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no E 63 532

Typical Applications

- AC motor starters
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

V_{RSM} V	V_{RRM} V_{DRM} V	$(dv/dt)_{cr}$ V/ μ s	I_{RMS} (maximum values for continuous operation) ($T_{case} = 85^\circ C$) 24 A ¹⁾ ; 30 A ²⁾ 24 A ¹⁾ ; 45 A ²⁾	
700	600	500	–	SKKQ 45/06
900	800	500	SKKQ 31/08	SKKQ 45/08
1300	1200	500	SKKQ 31/12	SKKQ 45/12
1500	1400	500	SKKQ 31/14	SKKQ 45/14
1700	1600	500	SKKQ 31/16	SKKQ 45/16

Symbol	Conditions	SKKQ 31	SKKQ 45
I_{RMS}	W1C; sin. 180; $T_{case} = 85^\circ C$	30 A ²⁾	45 A ²⁾
I_{TRMS}	sin. 180; $T_{case} = 85^\circ C$	21 A	32 A
I_{TSM}	$T_{vj} = 25^\circ C$; 10 ms $T_{vj} = 125^\circ C$; 10 ms	320 A 280 A	470 A 400 A
i^2t	$T_{vj} = 25^\circ C$; 8,3 ... 10 ms $T_{vj} = 125^\circ C$; 8,3 ... 10 ms	510 A ² s 390 A ² s	1100 A ² s 800 A ² s
t_{gd} t_{gr}	$T_{vj} = 25^\circ C$; $I_G = 1$ A; $di_G/dt = 1$ A/ μ s $V_D = 0,67 \cdot V_{DRM}$	1 μ s 1 μ s	
$(di/dt)_{cr}$	$T_{vj} = 125^\circ C$	100 A/ μ s	
t_q	$T_{vj} = 125^\circ C$	typ. 80 μ s	
I_H	$T_{vj} = 25^\circ C$; typ./max.	100/200 mA	
I_L	$T_{vj} = 25^\circ C$; $R_G = 33 \Omega$; typ./max.	250/400 mA	
V_T	$T_{vj} = 25^\circ C$; $I_T = 75$ A	max. 2,45 V	max. 1,8 V
$V_{T(TO)}$	$T_{vj} = 125^\circ C$	1,1 V	0,9 V
r_T	$T_{vj} = 125^\circ C$	20 m Ω	12 m Ω
I_{DD} ; I_{RD}	$T_{vj} = 125^\circ C$; $V_{DD} = V_{DRM}$; $V_{RD} = V_{RRM}$	max. 10 mA	max. 10 mA
V_{GT}	$T_{vj} = 25^\circ C$; d. c.	3 V	
I_{GT}	$T_{vj} = 25^\circ C$; d. c.	150 mA	
V_{GD}	$T_{vj} = 125^\circ C$; d. c.	0,25 V	
I_{GD}	$T_{vj} = 125^\circ C$; d. c.	5 mA	
R_{thjc}	cont.	1,6/0,8 $^\circ C/W$	1,2/0,6 $^\circ C/W$
R_{thch}	sin. 180 } per thyristor/per module	1,7/0,9 $^\circ C/W$	1,3/0,6 $^\circ C/W$
T_{vj}		0,2/0,1 $^\circ C/W$	
T_{stg}		– 40 ... +125 $^\circ C$ – 40 ... +125 $^\circ C$	
V_{isol}	a. c. 50 Hz; r.m.s.; 1 s/1 min	3600 V~ /3000 V~	
M_1	Case to heatsink; SI units/US units	1,5 Nm/13 lb. in. $\pm 15\%$ ³⁾	
a		5 · 9,81 m/s ²	
w	approx.	50 g	
Case	→ page B 1 – 34	A 41	

¹⁾ Using tin plated connectors with flexible leads of 6 mm² for the main terminals

²⁾ Flexible leads of 6 mm² soldered to the main terminals

³⁾ See the assembly instructions

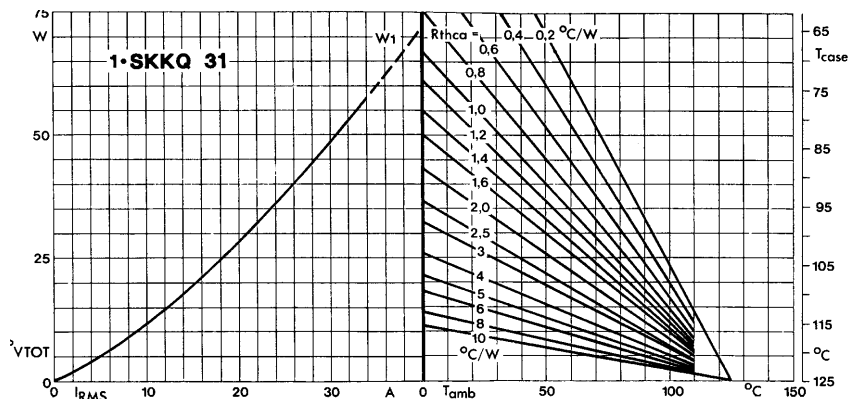


Fig. 2 a Power dissipation per module vs. rms current and case temperature

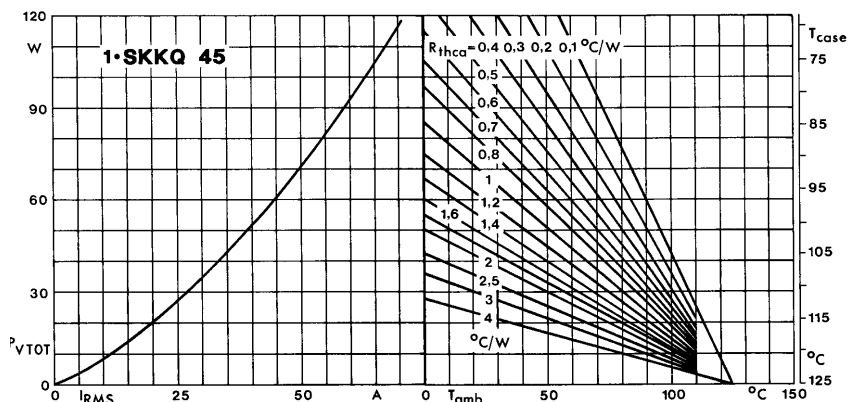


Fig. 2 b Power dissipation per module vs. rms current and case temperature

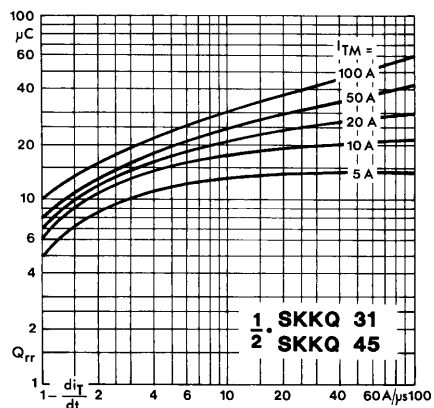


Fig. 5 Recovered charge vs. current decrease

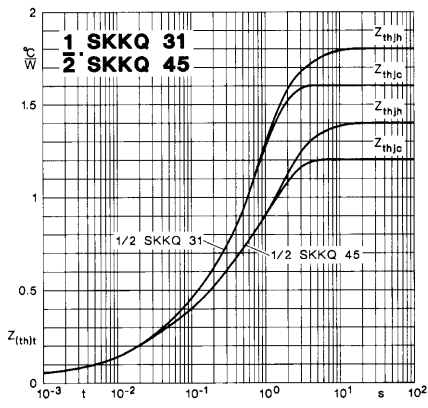


Fig. 6 Transient thermal impedance vs. time

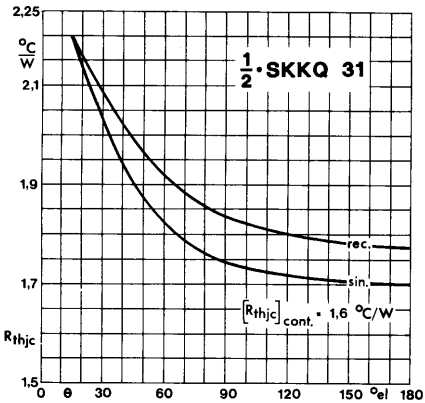


Fig. 7 a Thermal resistance vs. conduction angle

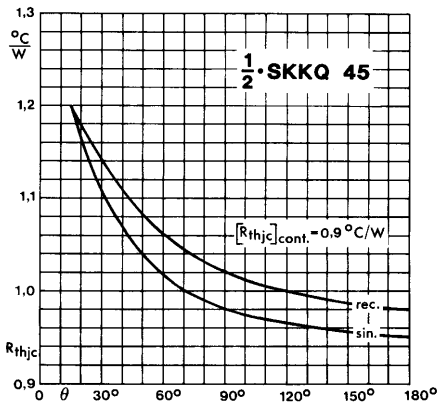


Fig. 7 b Thermal resistance vs. conduction angle

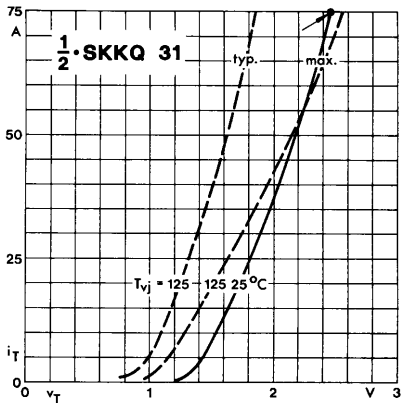


Fig. 8 a On-state characteristics

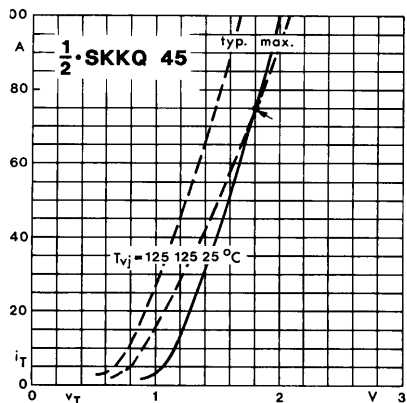


Fig. 8 b On-state characteristics

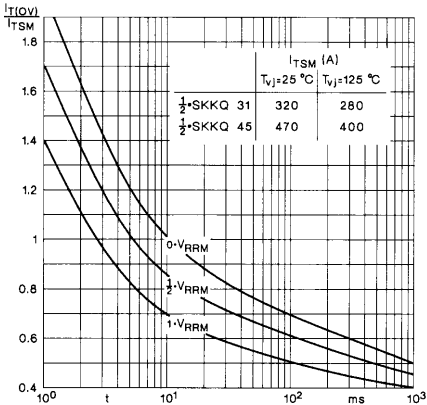


Fig. 9 Surge overload current vs. time

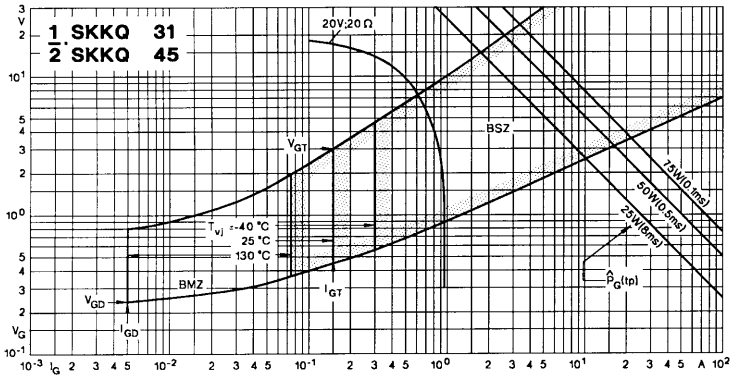
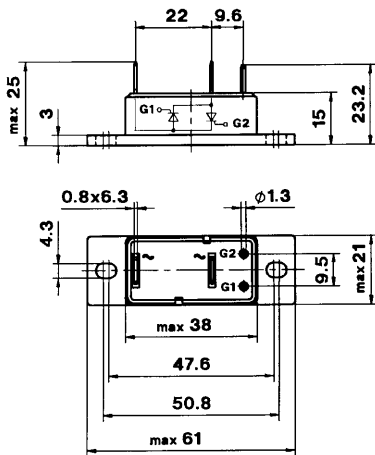


Fig. 10 Gate trigger characteristics

SKKQ 31
SKKQ 45
Case A 41
SEMIPACK® 0



Dimensions in mm